



PowerBase- Enhanced substrates and GaN pilot lines enabling compact power applications

The key objective of PowerBase “Enhanced substrates and GaN pilot lines enabling compact power applications” is to ensure the availability of Electronic Components and Systems (ECS) for key markets and for addressing societal challenges, aiming at keeping Europe at the forefront of the technology development, bridging the gap between research and exploitation, creating economic and employment growth in the European Union. The project PowerBase aims to contribute to the industrial ambition of value creation in Europe and fully supports this vision by addressing key topics of ECSEL multi annual strategic plan 2014. By positioning PowerBase as innovation action a clear focus on exploitation of the expected result is primary goal.

To expand the limits in current power semiconductor technologies the project focuses on setting up a qualified wide band gap GaN technology Pilot line, on expanding the limits of today’s silicon based substrate materials for power semiconductors, improving manufacturing efficiency by innovative automation, setting up of a GaN compatible chip embedding pilot line and demonstrating innovation potential in leading compact power application domains.

PowerBase is a project proposal with a vertical supply chain involved with contributions from partners in 7 European countries. This spans expertise from raw material research, process innovation, pilot line, assembly innovation and pilot line up to various application domains representing enhanced smart systems. The supporting partners consist of market leaders in their domain, having excellent technological background, which are fully committed to achieve the very challenging project goals.

The project PowerBase aims to have significant impact on mart regions. High tech jobs in the area of semiconductor technologies and micro/nano electronics in general are expressed core competences of the regions Austria: Carinthia, Styria, Germany: Sachsen, Bavaria and many other countries/ regions involved.

UNIPD Team Leader: Enrico Zanoni

Department: Information Engineering

Coordinator: Infineon Technologies Austria AG (Austria)

Other Participants:

Plansee SE (Austria)

Fronius International GmbH (Austria)

KAI (Austria)

AMS AG (Austria)

CISC Semiconductor GmbH (Austria)

Universität Graz (Austria)

Besi Austria GmbH (Austria)

CTR Carinthian Tech Research AG (Austria)



Interuniversitair Micro- Electronica Centrum VZW (Belgium)
EpiGan NV (Belgium)
Infineon Technologies Austria AG (Austria)
Siltronic AG (Germany)
Pac Tech- Packaging Technologies GmbH (Germany)
Baumann GmbH (Germany)
NanoFocus AG (Germany)
Fraunhofer- Gesellschaft zur Förderung der Angewandten Forschung E. v. (Germany)
Max Planck Institut für Eisenforschung GmbH (Germany)
Infineon Technologies Dresden GmbH (Germany)
NaMLab gGmbH (Germany)
Freiberger Compound Materials GmbH (Germany)
Technische Universität Dresden (Germany)
Fabmatics GmbH (Germany)
Infineon Technologies Italy (Italy)
Eltek AS (Norway)
Universitetet i Oslo (Norway)
Slovenká Technická Univerzita v Bratislave (Slovakia)
NanoDesign S.r.o. (Slovakia)
For Optimal Renewable Energy Systems S.l. (Spain)
Ikerlan S. Coop. (Spain)
Green Power Technologies S.l. (Spain)
Agencia Estatal Consejo Superior de Investigaciones Cientificas (Spain)
Quantemol Limited (United Kingdom)
SPTS Technologies Limited (United Kingdom)
Memsstar Limited (United Kingdom)
University Of Bristol (United Kingdom)
Besi Netherlands B.V. (Netherlands)
Trymax Semiconductor Equipment B.V. (Netherlands)
University of Padova (Italy)



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Find out more:

- <http://www.powerbase-project.eu/>
- https://cordis.europa.eu/project/rcn/197902_en.html